

CMOS single-chip 8-bit microcontroller

83C654/87C654

T-49-19-08

DESCRIPTION

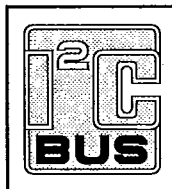
The 83C654/87C654 Single-Chip 8-Bit Microcontroller is manufactured in an advanced CMOS process and is a derivative of the 80C51 microcontroller family. The 83C654/87C654 has the same instruction set as the 80C51. Two versions of the derivative exist:

83C654 — 16k bytes mask programmable ROM

87C654 — EPROM version

This device provides architectural enhancements that make it applicable in a variety of applications for general control systems. The 8XC654 contains a non-volatile 16k x 8 read-only program memory (83C654) EPROM (87C654), a volatile 256 x 8 read/write data memory, four 8-bit I/O ports, two 16-bit timer/event counters (identical to the timers of the 80C51), a multi-source, two-priority-level, nested interrupt structure, an I²C interface, UART and on-chip oscillator and timing circuits. For systems that require extra capability, the 8XC654 can be expanded using standard TTL compatible memories and logic.

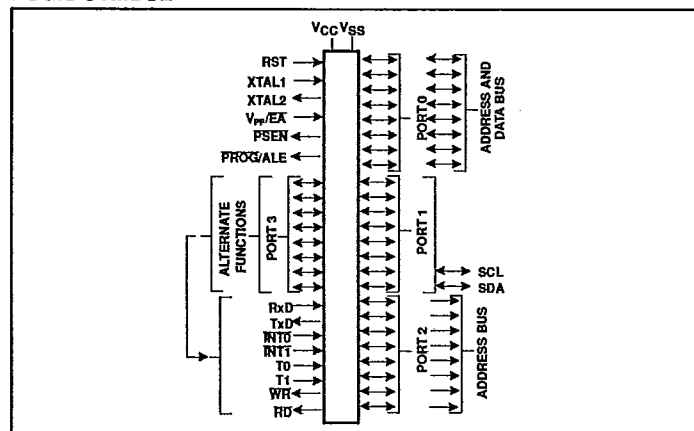
The device also functions as an arithmetic processor having facilities for both binary and BCD arithmetic plus bit-handling capabilities. The instruction set consists of over 100 instructions: 49 one-byte, 45 two-byte and 17 three-byte. With a 16(24)MHz crystal, 58% of the instructions are executed in 0.75(0.5) μ s and 40% in 1.5(1) μ s. Multiply and divide instructions require 3(2) μ s.



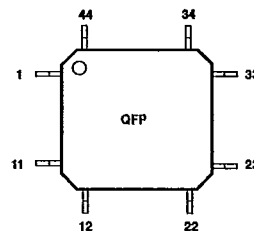
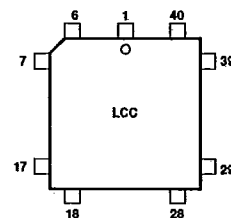
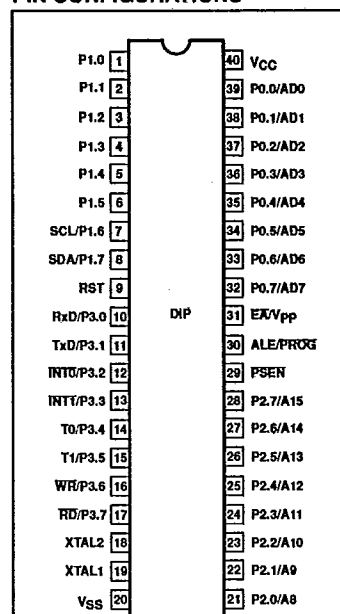
FEATURES

- 80C51 central processing unit
- 16k x 8 ROM expandable externally to 64k bytes
- 256 x 8 RAM, expandable externally to 64k bytes
- Two standard 16-bit timer/counters
- Four 8-bit I/O ports
- I²C-bus serial I/O port with byte oriented master and slave functions
- Full-duplex UART facilities
- Power control modes
 - Idle mode
 - Power-down mode
- ROM code protection
- Five package styles
- Extended temperature ranges
- OTP package available
- Three speed ranges
 - 16MHz
 - 20MHz (87C654 only)
 - 24MHz (83C654 only)

LOGIC SYMBOL



PIN CONFIGURATIONS



SEE PAGE 543 FOR QFP AND LCC PIN FUNCTIONS.

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PART NUMBER SELECTION

PHILIPS PART ORDER NUMBER PART MARKING		SIGNETICS PART ORDER NUMBER			TEMPERATURE °C AND PACKAGE	FREQ.
ROMless ¹	ROM	ROMless ¹	ROM	EPROM		
P80C652FBP	P83C654FBP/xxx	S80C652-4N40	S83C654-4N40	S87C654-4N40	0 to +70, Plastic DIP	16MHz
				S87C654-4F40	0 to +70, Ceramic DIP with window	16MHz
P80C652FBA	P83C654FBA/xxx	S80C652-4A44	S83C654-4A44	S87C654-4A44	0 to +70, Plastic PLCC	16MHz
				S87C654-4K44	0 to +70, Ceramic CLCC with window	16MHz
P80C652FBB	P83C654FBB/xxx	S80C652-4B44	S83C654-4B44	S87C654-4B44	0 to +70, Plastic QFP	16MHz
P80C652FFP	P83C654FFP/xxx	S80C652-5N40	S83C654-5N40	S87C654-5N40	-40 to +85, Plastic DIP	16MHz
				S87C654-5F40	-40 to +85, Ceramic DIP with window	16MHz
P80C652FFA	P83C654FFA/xxx	S80C652-5A44	S83C654-5A44	S87C654-5A44	-40 to +85, Plastic PLCC	16MHz
				S87C654-5K44	-40 to +85, Ceramic CLCC with window	16MHz
P80C652FFB	P83C654FFB/xxx	S80C652-5B44	S83C654-5B44	S87C654-5B44	-40 to +85, Plastic QFP	16MHz
P80C652FHP	P83C654FHP/xxx	S80C652-6N40	S83C654-6N40		-40 to +125, Plastic DIP	16MHz
P80C652FHA	P83C654FHA/xxx	S80C652-6A44	S83C654-6A44		-40 to +125, Plastic PLCC	16MHz
P80C652FHB	P83C654FHB/xxx	S80C652-6B44	S83C654-6B44		-40 to +125, Plastic QFP	16MHz
				S87C654-7N40	0 to +70, Plastic DIP	20MHz
				S87C654-7F40	0 to +70, Ceramic DIP with window	20MHz
				S87C654-7A44	0 to +70, Plastic PLCC	20MHz
				S87C654-7K44	0 to +70, Ceramic CLCC with window	20MHz
				S87C654-7B44	0 to +70, Plastic QFP	20MHz
				S87C654-8N40	-40 to +85, Plastic DIP	20MHz
				S87C654-8F40	-40 to +85, Ceramic DIP with window	20MHz
				S87C654-8A44	-40 to +85, Plastic PLCC	20MHz
				S87C654-8K44	-40 to +85, Ceramic CLCC with window	20MHz
				S87C654-8B44	-40 to +85, Plastic QFP	20MHz
P80C652IBP	P83C654IBP/xxx	S80C652-AN40	S83C654-AN40		0 to +70, Plastic DIP	24MHz
P80C652IBA	P83C654IBA/xxx	S80C652-AA44	S83C654-AA44		0 to +70, Plastic PLCC	24MHz
P80C652IBB	P83C654IBB/xxx	S80C652-AB44	S83C654-AB44		0 to +70, Plastic QFP	24MHz
P80C652IFP	P83C654IFP/xxx	S80C652-BN40	S83C654-BN40		-40 to +85, Plastic DIP	24MHz
P80C652IFA	P83C654IFA/xxx	S80C652-BA44	S83C654-BA44		-40 to +85, Plastic PLCC	24MHz
P80C652IFB	P83C654IFB/xxx	S80C652-BB44	S83C654-BB44		-40 to +85, Plastic QFP	24MHz

NOTES:

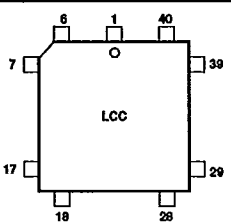
- For full specification, see the 80C652/83C652/87C652 data sheet.
- 83C654 frequency range is 1.2MHz – 16MHz or 1.2MHz – 24MHz.
- 87C654 frequency range is 3.5MHz – 16MHz or 3.5MHz – 20MHz.
- xxx denotes the ROM code number.

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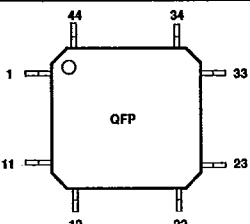
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LCC PIN FUNCTIONS



Pin	Function	Pin	Function
1	NC	23	NC
2	P1.0	24	P2.0/A8
3	P1.1	25	P2.1/A9
4	P1.2	26	P2.2/A10
5	P1.3	27	P2.3/A11
6	P1.4	28	P2.4/A12
7	P1.5	29	P2.5/A13
8	P1.6/SCL	30	P2.6/A14
9	P1.7/SDA	31	P2.7/A15
10	RST	32	PSEN
11	P3.0/RxD	33	ALE/PROG
12	NC	34	NC
13	P3.1/TxD	35	EA/Vpp
14	P3.2/INT0	36	P0.7/AD7
15	P3.3/INTT	37	P0.6/AD6
16	P3.4/T0	38	P0.5/AD5
17	P3.5/T1	39	P0.4/AD4
18	P3.6/WR	40	P0.3/AD3
19	P3.7/RD	41	P0.2/AD2
20	XTAL2	42	P0.1/AD1
21	XTAL1	43	P0.0/AD0
22	VSS	44	VCC

QFP PIN FUNCTIONS



Pin	Function	Pin	Function
1	P1.5	23	P2.5/A13
2	P1.6/SCL	24	P2.6/A14
3	P1.7/SDA	25	P2.7/A15
4	RST	26	PSEN
5	P3.0/RxD	27	ALE/PROG
6	NC	28	NC
7	P3.1/TxD	29	EA/Vpp
8	P3.2/INT0	30	P0.7/AD7
9	P3.3/INTT	31	P0.6/AD6
10	P3.4/T0	32	P0.5/AD5
11	P3.5/T1	33	P0.4/AD4
12	P3.6/WR	34	P0.3/AD3
13	P3.7/RD	35	P0.2/AD2
14	XTAL2	36	P0.1/AD1
15	XTAL1	37	P0.0/AD0
16	VSS	38	VCC
17	NC	39	NC
18	P2.0/A8	40	P1.0
19	P2.1/A9	41	P1.1
20	P2.2/A10	42	P1.2
21	P2.3/A11	43	P1.3
22	P2.4/A12	44	P1.4

NOTES TO QFP ONLY:

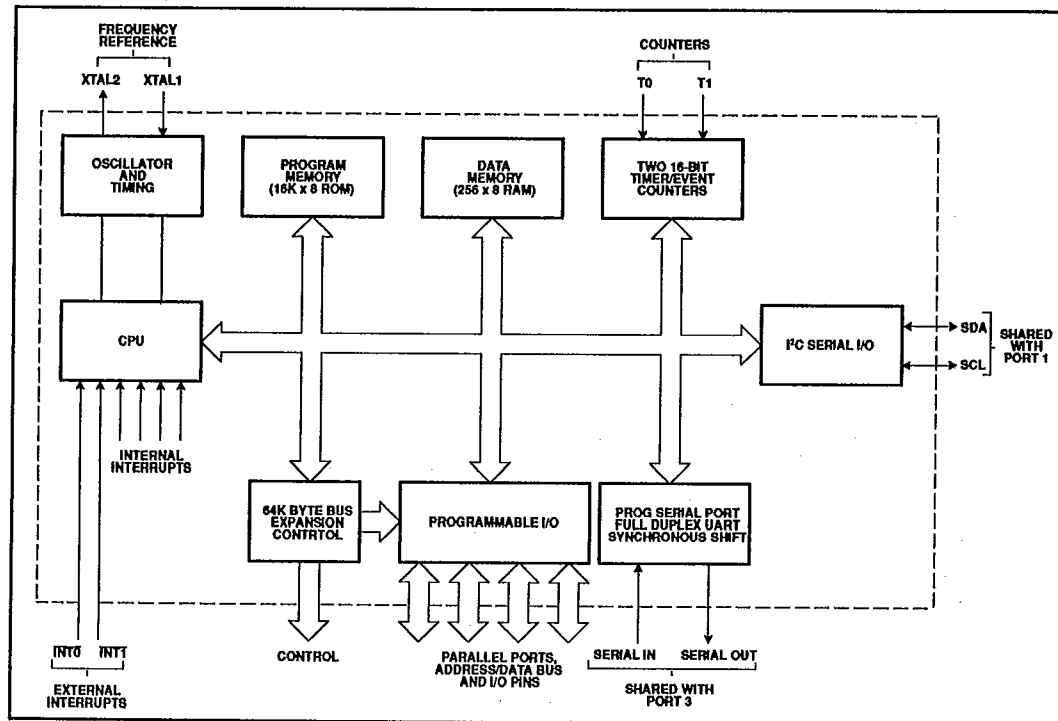
- Due to EMC improvements, it is advised to connect pins 6, 28, 39 to V_{SS} on the 80C652/83C654.

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BLOCK DIAGRAM



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PIN DESCRIPTIONS

MNEMONIC	PIN NUMBER			TYPE	NAME AND FUNCTION
	DIP	LCC	QFP		
V _{SS}	20	22	16	I	Ground: 0V reference.
V _{CC}	40	44	38	I	Power Supply: This is the power supply voltage for normal, idle, and power-down operation.
P0.0-0.7	39-32	43-36	37-30	I/O	Port 0: Port 0 is an open-drain, bidirectional I/O port. Port 0 pins that have 1s written to them float and can be used as high-impedance inputs. Port 0 is also the multiplexed low-order address and data bus during accesses to external program and data memory. In this application, it uses strong internal pull-ups when emitting 1s. Port 0 also outputs the code bytes during program verification in the 87C654. External pull-ups are required during program verification.
P1.0-P1.7	1-8	2-9	40-44, 1-3	I/O	Port 1: Port 1 is an 8-bit bidirectional I/O port with internal pull-ups, except P1.6 and P1.7 which are open drain. Port 1 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, port 1 pins that are externally pulled low will source current because of the internal pull-ups. (See DC Electrical Characteristics: I _{IL}). Port 1 also receives the low-order address byte during program memory verification. Alternate functions include: SCL: I ² C-bus serial port clock line. SDA: I ² C-bus serial port data line.
P1.6	7	8	2	I/O	Port 2: Port 2 is an 8-bit bidirectional I/O port with internal pull-ups. Port 2 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, port 2 pins that are externally being pulled low will source current because of the internal pull-ups. (See DC Electrical Characteristics: I _{IL}). Port 2 emits the high-order address byte during fetches from external program memory and during accesses to external data memory that use 16-bit addresses (MOVX @DPTR). In this application, it uses strong internal pull-ups when emitting 1s. During accesses to external data memory that use 8-bit addresses (MOV @Ri), port 2 emits the contents of the P2 special function register.
P1.7	8	9	3	I/O	
P2.0-P2.7	21-28	24-31	18-25	I/O	Port 3: Port 3 is an 8-bit bidirectional I/O port with internal pull-ups. Port 3 pins that have 1s written to them are pulled high by the internal pull-ups and can be used as inputs. As inputs, port 3 pins that are externally being pulled low will source current because of the pull-ups. (See DC Electrical Characteristics: I _{IL}). Port 3 also serves the special features of the 80C51 family, as listed below: RxD (P3.0): Serial input port TxD (P3.1): Serial output port INT0 (P3.2): External interrupt INT1 (P3.3): External interrupt T0 (P3.4): Timer 0 external input T1 (P3.5): Timer 1 external input WR (P3.6): External data memory write strobe RD (P3.7): External data memory read strobe
P3.0-P3.7	10-17	11, 13-19	5, 7-13	I/O	
	10	11	5	I	
	11	13	7	O	
	12	14	8	I	
	13	15	9	I	
	14	16	10	I	
	15	17	11	I	
	16	18	12	O	
	17	19	13	O	
RST	9	10	4	I	Reset: A high on this pin for two machine cycles while the oscillator is running, resets the device. An internal diffused resistor to V _{SS} permits a power-on reset using only an external capacitor to V _{CC} .
ALE/PROG	30	33	27	I/O	Address Latch Enable/Program Pulse: Output pulse for latching the low byte of the address during an access to external memory. In normal operation, ALE is emitted at a constant rate of 1/6 the oscillator frequency, and can be used for external timing or clocking. Note that one ALE pulse is skipped during each access to external data memory. This pin is also the program pulse input (PROG) during EPROM programming.
PSEN	29	32	26	O	Program Store Enable: The read strobe to external program memory. When the 87C654 is executing code from the external program memory, PSEN is activated twice each machine cycle, except that two PSEN activations are skipped during each access to external data memory. PSEN is not activated during fetches from internal program memory.
EA/V _{PP}	31	35	29	I	External Access Enable/Programming Supply Voltage: EA must be externally held low to enable the device to fetch code from external program memory locations 0000H and 3FFFH. If EA is held high, the device executes from internal program memory unless the program counter contains an address greater than 3FFFH. This pin also receives the 12.75V programming supply voltage (V _{PP}) during EPROM programming.
XTAL1	19	21	15	I	Crystal 1: Input to the inverting oscillator amplifier and input to the internal clock generator circuits.
XTAL2	18	20	14	O	Crystal 2: Output from the inverting oscillator amplifier.

NOTE:

To avoid "latch-up" effect at power-on, the voltage on any pin at any time must not be higher than V_{CC} + 0.5V or V_{SS} - 0.5V, respectively.

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**ROM CODE PROTECTION
(83C654)**

The 83C654 has an additional security feature. ROM code protection may be selected by setting a mask-programmable security bit (i.e., user dependent). This feature may be requested during ROM code submission. When selected, the ROM code is protected and cannot be read out at any time by any test mode or by any instruction in the external program memory space.

The MOV_C instructions are the only instructions that have access to program code in the internal or external program memory. The \overline{EA} input is latched during RESET and is "don't care" after RESET. This implementation prevents reading internal program code by switching from external program memory to internal program memory during a MOV_C instruction or any other instruction that uses immediate data.

**OSCILLATOR
CHARACTERISTICS**

XTAL1 and XTAL2 are the input and output, respectively, of an inverting amplifier. The pins can be configured for use as an on-chip oscillator, as shown in the Logic Symbol, page 541.

To drive the device from an external clock source, XTAL1 should be driven while XTAL2 is left unconnected. There are no requirements on the duty cycle of the external clock signal, because the input to the internal clock circuitry is through a divide-by-two flip-flop. However, minimum and maximum high and low times specified in the data sheet must be observed.

Reset

A reset is accomplished by holding the RST pin high for at least two machine cycles (24 oscillator periods), while the oscillator is running. To insure a good power-on reset, the RST pin must be high long enough to allow the oscillator time to start up (normally a few milliseconds) plus two machine cycles. At power-on, the voltage on V_{CC} and RST must come up at the same time for a proper start-up.

Idle Mode

In the idle mode, the CPU puts itself to sleep while all of the on-chip peripherals stay active. The instruction to invoke the idle mode is the last instruction executed in the normal operating mode before the idle mode is activated. The CPU contents, the on-chip RAM, and all of the special function registers remain intact during this mode. The idle mode can be terminated either by any enabled interrupt (at which time the process is picked up at the interrupt service routine and continued), or by a hardware reset which starts the processor in the same manner as a power-on reset.

Power-Down Mode

In the power-down mode, the oscillator is stopped and the instruction to invoke power-down is the last instruction executed. Only the contents of the on-chip RAM are preserved. A hardware reset is the only way to terminate the power-down mode. The control bits for the reduced power modes are in the special function register PCON. Table 1 shows the state of the I/O ports during low current operating modes.

Table 1. External Pin Status During Idle and Power-Down Mode

MODE	PROGRAM MEMORY	ALE	PSEN	PORT 0	PORT 1	PORT 2	PORT 3
Idle	Internal	1	1	Data	Data	Data	Data
Idle	External	1	1	Float	Data	Address	Data
Power-down	Internal	0	0	Data	Data	Data	Data
Power-down	External	0	0	Float	Data	Data	Data

Serial Control Register (S1CON) – See Table 2

S1CON (06H) CR2 ENS1 STA STO SI AA CR1 CR0

Bits CR0, CR1 and CR2 determine the serial clock frequency that is generated in the master mode of operation.

Table 2. Serial Clock Rates

CR2	CR1	CR0	BIT FREQUENCY (kHz) AT f_{osc}				f_{osc} DIVIDED BY
			6MHz	12MHz	16MHz	24MHz	
0	0	0	23	47	62.5	94	256
0	0	1	27	54	71	107 ¹	224
0	1	0	31.25	62.5	83.3	125 ¹	192
0	1	1	37	75	100	150 ¹	160
1	0	0	6.25	12.5	17	25	960
1	0	1	50	100	133 ¹	200 ¹	120
1	1	0	100	200 ¹	267 ¹	400 ¹	60
1	1	1	0.25 < 62.5	0.5 < 62.5	0.67 < 56	0.98 < 50	96 × (256 – (reload value Timer 1)) (Reload value range: 0 – 254 in mode 2)

NOTES:

1. These frequencies exceed the upper limit of 100kHz of the I²C-bus specification and cannot be used in an I²C-bus application.

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ABSOLUTE MAXIMUM RATINGS^{1, 2, 3}

PARAMETER	RATING	UNIT
Storage temperature range	-65 to +150	°C
Voltage on \overline{EA}/V_{PP} to V_{SS} (87C654 only)	-0.5 to +13	V
Voltage on any other pin to V_{SS}	-0.5 to +6.5	V
Input, output current on any single pin	±5	mA
Power dissipation (based on package heat transfer limitations, not device power consumption)	1	W

NOTES:

- Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any conditions other than those described in the AC and DC Electrical Characteristics section of this specification is not implied.
- This product includes circuitry specifically designed for the protection of its internal devices from the damaging effects of excessive static charge. Nonetheless, it is suggested that conventional precautions be taken to avoid applying greater than the rated maxima.
- Parameters are valid over operating temperature range unless otherwise specified. All voltages are with respect to V_{SS} unless otherwise noted.

DEVICE SPECIFICATIONS

TYPE	SUPPLY VOLTAGE (V)		FREQUENCY (MHz)		TEMPERATURE RANGE (°C)
	MIN.	MAX.	MIN.	MAX.	
P83C654FB	4.0	6.0	1.2	16	0 to +70
S87C654-4	4.5	5.5	3.5	16	0 to +70
P83C654FF	4.0	6.0	1.2	16	-40 to +85
S87C654-5	4.5	5.5	3.5	16	-40 to +85
P83C654FH	4.5	5.5	1.2	16	-40 to +125
S87C654-7	4.5	5.5	3.5	20	0 to +70
S87C654-8	4.5	5.5	3.5	20	-40 to +85
P83C654IB	4.5	5.5	1.2	24	0 to +70
P83C654IF	4.5	5.5	1.2	24	-40 to +85

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DC ELECTRICAL CHARACTERISTICS

 $V_{SS} = 0V$

SYMBOL	PARAMETER	PART TYPE	TEST CONDITIONS	LIMITS		UNIT
				MIN.	MAX.	
V_{IL}	Input low voltage, except EA, P1.6/SCL, P1.7/SDA	0 to +70°C -40 to +85°C -40 to +125°C		-0.5 -0.5 -0.5	$0.2V_{CC}-0.1$ $0.2V_{CC}-0.15$ $0.2V_{CC}-0.25$	V V V
V_{IL1}	Input low voltage to EA	0 to +70°C -40 to +85°C -40 to +125°C		-0.5 -0.5 -0.5	$0.2V_{CC}-0.3$ $0.2V_{CC}-0.35$ $0.2V_{CC}-0.45$	V V V
V_{IL2}	Input low voltage to P1.6/SCL, P1.7/SDA ⁶			-0.5	$0.3V_{CC}$	V
V_{IH}	Input high voltage, except XTAL1, RST, P1.6/SCL, P1.7/SDA	0 to +70°C -40 to +85°C -40 to +125°C		$0.2V_{CC}+0.9$ $0.2V_{CC}+1.0$ $0.2V_{CC}+1.0$	$V_{CC}+0.5$ $V_{CC}+0.5$ $V_{CC}+0.5$	V V V
V_{IH1}	Input high voltage, XTAL1, RST	0 to +70°C -40 to +85°C -40 to +125°C		$0.7V_{CC}$ $0.7V_{CC}+0.1$ $0.7V_{CC}+0.1$	$V_{CC}+0.5$ $V_{CC}+0.5$ $V_{CC}+0.5$	V V V
V_{IH2}	Input high voltage, P1.6/SCL, P1.7/SDA ⁶			$0.7V_{CC}$	6.0	V
V_{OL}	Output low voltage, ports 1, 2, 3, except P1.6/SCL, P1.7/SDA		$I_{OL} = 1.6mA^{8,9}$		0.45	V
V_{OL1}	Output low voltage, port 0, ALE, PSEN		$I_{OL} = 3.2mA^{8,9}$		0.45	V
V_{OL2}	Output low voltage, P1.6/SCL, P1.7/SDA		$I_{OL} = 3.0mA$		0.4	V
V_{OH}	Output high voltage, ports 1, 2, 3		$I_{OH} = -60\mu A$ $I_{OH} = -25\mu A$ $I_{OH} = -10\mu A$	2.4 $0.75V_{CC}$ $0.9V_{CC}$		V V V
V_{OH1}	Output high voltage; port 0 in external bus mode, ALE, PSEN, RST ¹⁰		$I_{OH} = -400\mu A$ $I_{OH} = -150\mu A$ $I_{OH} = -40\mu A$	2.4 $0.75V_{CC}$ $0.9V_{CC}$		V V V
I_{IL}	Logical 0 input current, ports 1, 2, 3, 4, except P1.6/SCL, P1.7/SDA	0 to +70°C -40 to +85°C -40 to +125°C	$V_{IN} = 0.45V$		-50 -75 -75	μA μA μA
I_{TL}	Logical 1-to-0 transition current, ports 1, 2, 3, except P1.6/SCL, P1.7/SDA	0 to +70°C -40 to +85°C -40 to +125°C	See note 7		-650 -750 -750	μA μA μA
I_{L1}	Input leakage current, port 0		$0.45V < V_I < V_{CC}$		± 10	μA
I_{L2}	Input leakage current, P1.6/SCL, P1.7/SDA		$0V < V_I < 6.0V$ $0V < V_{CC} < 6.0V$		± 10	μA μA
I_{CC}	Power supply current: Active mode @ 16MHz (83C654) ^{2, 11} Active mode @ 16MHz (87C654) ² Active mode @ 24MHz (80/83C654) ^{2, 11} Idle mode @ 16MHz (83C654) ^{3, 11} Idle mode @ 16MHz (87C654) ³ Idle mode @ 24MHz (80/83C654) ^{3, 11} Power down mode ^{4, 5} Power down mode (87C654) ^{4, 5} Power down mode (80/83C654) ^{4, 5}	-40 to +85°C -40 to +125°C	See note 1 $V_{CC}=6.0V$ $V_{CC}=5.5V$		28 25 35 6 6 7 50 135 100	mA mA mA mA mA mA μA μA μA
R_{RST}	Internal reset pull-down resistor			50	150	k Ω
C_{IO}	Pin capacitance		Freq.=1MHz		10	pF

NOTES: See Next Page.

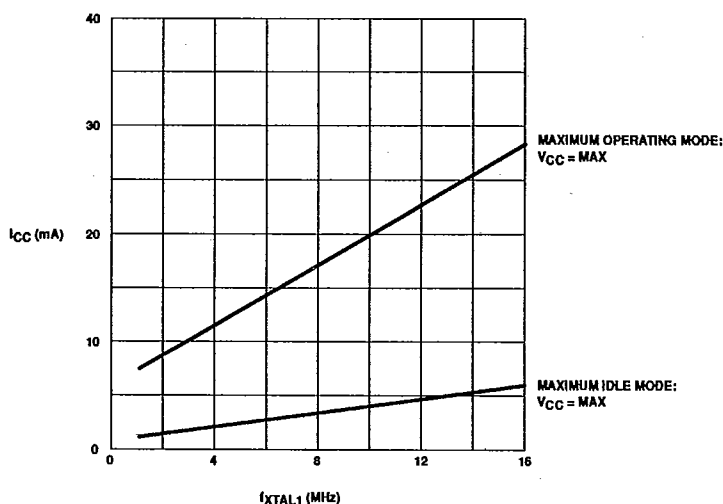
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NOTES FOR DC ELECTRICAL CHARACTERISTICS:

- See Figures 9 through 12 for I_{CC} test conditions.
- The operating supply current is measured with all output pins disconnected; XTAL1 driven with $t_r = t_f = 10\text{ns}$; $V_{IL} = V_{SS} + 0.5\text{V}$; $V_{IH} = V_{CC} - 0.5\text{V}$; XTAL2 not connected; EA = RST = Port 0 = P1.6 = P1.7 = V_{CC} ; $f_{CLK} = 16\text{MHz}$. See Figure 9.
- The idle mode supply current is measured with all output pins disconnected; XTAL1 driven with $t_r = t_f = 10\text{ns}$; $V_{IL} = V_{SS} + 0.5\text{V}$; $V_{IH} = V_{CC} - 0.5\text{V}$; XTAL2 not connected; Port 0 = P1.6 = P1.7 = V_{CC} ; EA = RST = V_{SS} ; $f_{CLK} = 16\text{MHz}$. See Figure 10.
- The power-down current is measured with all output pins disconnected; XTAL2 not connected; Port 0 = P1.6 = P1.7 = V_{CC} ; EA = RST = V_{SS} . See Figure 12.
- $2\text{V} \leq V_{PD} \leq V_{CCmax}$.
- The input threshold voltage of P1.6 and P1.7 (SIO1) meets the I²C specification, so an input voltage below $0.3V_{CC}$ will be recognized as a logic 0 while an input voltage above $0.7V_{CC}$ will be recognized as a logic 1.
- Pins of ports 1, 2, and 3 source a transition current when they are being externally driven from 1 to 0. The transition current reaches its maximum value when V_{IN} is approximately 2V.
- Capacitive loading on ports 0 and 2 may cause spurious noise to be superimposed on the V_{OL} s of ALE and ports 1 and 3. The noise is due to external bus capacitance discharging into the port 0 and port 2 pins when these pins make 1-to-0 transitions during bus operations. In the worst cases (capacitive loading > 100pF), the noise pulse on the ALE pin may exceed 0.8V. In such cases, it may be desirable to qualify ALE with a Schmitt Trigger, or use an address latch with a Schmitt Trigger STROBE input. I_{OL} can exceed these conditions provided that no single output sinks more than 5mA and no more than two outputs exceed the test conditions.
- Under steady state (non-transient) conditions, I_{OL} must be externally limited as follows: Maximum $I_{OL} = 10\text{mA}$ per port pin; Maximum $I_{OL} = 26\text{mA}$ total for Port 0; Maximum $I_{OL} = 15\text{mA}$ total for Ports 1, 2, and 3; Maximum $I_{OL} = 71\text{mA}$ total for all output pins. If I_{OL} exceeds the test conditions, V_{OL} may exceed the related specification. Pins are not guaranteed to sink current greater than the listed test conditions.
- Capacitive loading on ports 0 and 2 may cause the V_{OH} on ALE and PSEN to momentarily fall below the $0.9V_{CC}$ specification when the address bits are stabilizing.
- I_{CCMAX} for the 80/83C654 at the other frequencies can be derived from Figure 1, where FREQ is the external oscillator frequency in MHz. I_{CCMAX} is given in mA.



VALID ONLY WITHIN FREQUENCY SPECIFICATIONS OF DEVICE UNDER TEST.

Figure 1. I_{CC} vs. Frequency

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AC ELECTRICAL CHARACTERISTICS^{1,2}

SYMBOL	FIGURE	PARAMETER	16MHz CLOCK		VARIABLE CLOCK		UNIT
			MIN	MAX	MIN	MAX	
f_{CLCL}	2	Oscillator frequency			1.2 (3.5)	16	MHz
t_{LHLL}	2	ALE pulse width	85		$2t_{\text{CLCL}}-40$		ns
t_{AVLL}	2	Address valid to ALE low	8		$t_{\text{CLCL}}-55$		ns
t_{LLAX}	2	Address hold after ALE low	28		$t_{\text{CLCL}}-35$		ns
t_{LLIV}	2	ALE low to valid instruction in		150		$4t_{\text{CLCL}}-100$	ns
t_{LLPL}	2	ALE low to PSEN low	23		$t_{\text{CLCL}}-40$		ns
t_{PLPH}	2	PSEN pulse width	143		$3t_{\text{CLCL}}-45$		ns
t_{PLIV}	2	PSEN low to valid instruction in		83		$3t_{\text{CLCL}}-105$	ns
t_{PXIX}	2	Input instruction hold after PSEN	0		0		ns
t_{PXIZ}	2	Input instruction float after PSEN		38		$t_{\text{CLCL}}-25$	ns
t_{AVIV}	2	Address to valid instruction in		208		$5t_{\text{CLCL}}-105$	ns
t_{PLAZ}	2	PSEN low to address float		10		10	ns
Data Memory							
t_{AVLL}	3, 4	Address valid to ALE low	28		$t_{\text{CLCL}}-35$		ns
t_{RLRH}	3, 4	RD pulse width	275		$6t_{\text{CLCL}}-100$		ns
t_{WLWH}	3, 4	WR pulse width	275		$6t_{\text{CLCL}}-100$		ns
t_{RLDV}	3, 4	RD low to valid data in		148		$5t_{\text{CLCL}}-165$	ns
t_{RHDX}	3, 4	Data hold after RD	0		0		ns
t_{RHDX}	3, 4	Data float after RD		55		$2t_{\text{CLCL}}-70$	ns
t_{LLDV}	3, 4	ALE low to valid data in		350		$8t_{\text{CLCL}}-150$	ns
t_{AVDV}	3, 4	Address to valid data in		398		$9t_{\text{CLCL}}-165$	ns
t_{LLWL}	3, 4	ALE low to RD or WR low	138	238	$3t_{\text{CLCL}}-50$	$3t_{\text{CLCL}}+50$	ns
t_{AVWL}	3, 4	Address valid to WR low or RD low	120		$4t_{\text{CLCL}}-130$		ns
t_{QVWX}	3, 4	Data valid to WR transition	3		$t_{\text{CLCL}}-60$		ns
t_{OW}	3, 4	Data setup time before WR	288		$7t_{\text{CLCL}}-150$		ns
t_{WHOX}	3, 4	Data hold after WR	13		$t_{\text{CLCL}}-50$		ns
t_{RLAZ}	3, 4	RD low to address float		0		0	ns
t_{WHLH}	3, 4	RD or WR high to ALE high	23	103	$t_{\text{CLCL}}-40$	$t_{\text{CLCL}}+40$	ns
Shift Register							
t_{XLXL}	5	Serial port clock cycle time ³	0.75		$12t_{\text{CLCL}}$		μs
t_{QVXH}	5	Output data setup to clock rising edge ³	492		$10t_{\text{CLCL}}-133$		ns
t_{HXOX}	5	Output data hold after clock rising edge ³	80		$2t_{\text{CLCL}}-117$		ns
t_{HXDX}	5	Input data hold after clock rising edge ³	0		0		ns
t_{HXDV}	5	Clock rising edge to input data valid ³		492		$10t_{\text{CLCL}}-133$	ns
External Clock							
t_{CHCX}	6	High time ³	20		20	$t_{\text{CLCL}} - t_{\text{LOW}}$	ns
t_{CLCX}	6	Low time ³	20		20	$t_{\text{CLCL}} - t_{\text{HIGH}}$	ns
t_{CLCH}	6	Rise time ³		20		20	ns
t_{CHCL}	6	Fall time ³		20		20	ns

NOTES:

- Parameters are valid over operating temperature range unless otherwise specified.
- Load capacitance for port 0, ALE, and PSEN = 100pF, load capacitance for all other outputs = 80pF.
- These values are characterized but not 100% production tested.

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AC ELECTRICAL CHARACTERISTICS^{1, 2}

SYMBOL	FIGURE	PARAMETER	24MHz CLOCK		VARIABLE CLOCK		UNIT
			MIN	MAX	MIN	MAX	
1/t _{CLCL}	2	Oscillator frequency			1.2 (3.5)	24 (20)	MHz
t _{LHLL}	2	ALE pulse width	43		2t _{CLCL} -40		ns
t _{AVLL}	2	Address valid to ALE low	17		t _{CLCL} -25		ns
t _{LLAX}	2	Address hold after ALE low	17		t _{CLCL} -25		ns
t _{LLIV}	2	ALE low to valid instruction in		102		4t _{CLCL} -65	ns
t _{LLPL}	2	ALE low to PSEN low	17		t _{CLCL} -25		ns
t _{PLPH}	2	PSEN pulse width	80		3t _{CLCL} -45		ns
t _{PLIV}	2	PSEN low to valid instruction in		65		3t _{CLCL} -60	ns
t _{PXIX}	2	Input instruction hold after PSEN	0		0		ns
t _{PXIZ}	2	Input instruction float after PSEN		17		t _{CLCL} -25	ns
t _{AVIV}	2	Address to valid instruction in		128		5t _{CLCL} -80	ns
t _{PLAZ}	2	PSEN low to address float		10		10	ns
Data Memory							
t _{AVLL}	3, 4	Address valid to ALE low	17		t _{CLCL} -25		ns
t _{RLRH}	3, 4	RD pulse width	150		6t _{CLCL} -100		ns
t _{WLWH}	3, 4	WR pulse width	150		6t _{CLCL} -100		ns
t _{RLDV}	3, 4	RD low to valid data in		118		5t _{CLCL} -90	ns
t _{RHDX}	3, 4	Data hold after RD	0		0		ns
t _{RHDZ}	3, 4	Data float after RD		55		2t _{CLCL} -28	ns
t _{LLDV}	3, 4	ALE low to valid data in		183		8t _{CLCL} -150	ns
t _{AVDV}	3, 4	Address to valid data in		210		9t _{CLCL} -165	ns
t _{LLWL}	3, 4	ALE low to RD or WR low	75	175	3t _{CLCL} -50	3t _{CLCL} +50	ns
t _{AVWL}	3, 4	Address valid to WR low or RD low	92		4t _{CLCL} -75		ns
t _{QVWX}	3, 4	Data valid to WR transition	12		t _{CLCL} -30		ns
t _{OW}	3, 4	Data setup time before WR	162		7t _{CLCL} -130		ns
t _{WHQX}	3, 4	Data hold after WR	17		t _{CLCL} -25		ns
t _{RLAZ}	3, 4	RD low to address float		0		0	ns
t _{WHLH}	3, 4	RD or WR high to ALE high	17	67	t _{CLCL} -25	t _{CLCL} +25	ns
Shift Register							
t _{XLXL}	5	Serial port clock cycle time ³	0.5		12t _{CLCL}		μs
t _{QVXH}	5	Output data setup to clock rising edge ³	283		10t _{CLCL} -133		ns
t _{XHOX}	5	Output data hold after clock rising edge ³	23		2t _{CLCL} -60		ns
t _{XHDX}	5	Input data hold after clock rising edge ³	0		0		ns
t _{XHDV}	5	Clock rising edge to input data valid ³		283		10t _{CLCL} -133	ns
External Clock							
t _{CHOX}	6	High time ³	17		17	t _{CLCL} - t _{LOW}	ns
t _{CLCX}	6	Low time ³	17		17	t _{CLCL} - t _{HIGH}	ns
t _{CLCH}	6	Rise time ³		20		20	ns
t _{CHCL}	6	Fall time ³		20		20	ns

NOTES:

- Parameters are valid over operating temperature range unless otherwise specified.
- Load capacitance for port 0, ALE, and PSEN = 100pF, load capacitance for all other outputs = 80pF.
- These values are characterized but not 100% production tested.

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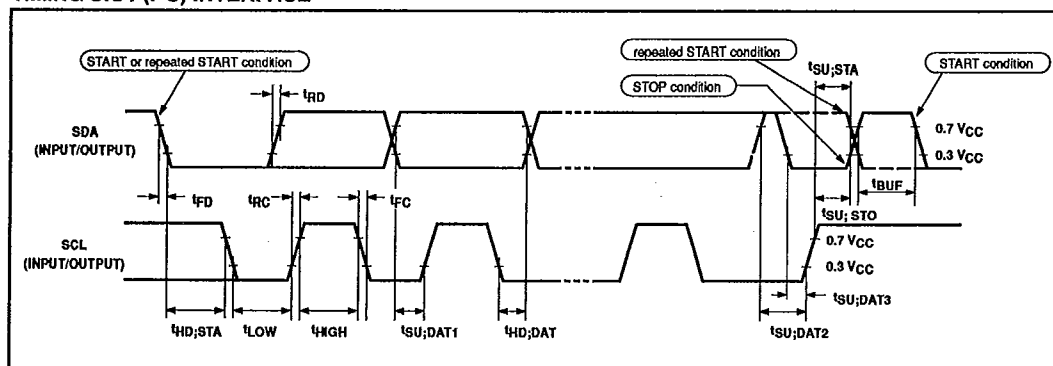
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AC ELECTRICAL CHARACTERISTICS – I²C INTERFACE

SYMBOL	PARAMETER	INPUT	OUTPUT
SCL TIMING CHARACTERISTICS			
$t_{HD; STA}$	START condition hold time	$\geq 14 t_{CLCL}$	$> 4.0\mu s^1$
t_{LOW}	SCL LOW time	$\geq 16 t_{CLCL}$	$> 4.7\mu s^1$
t_{HIGH}	SCL HIGH time	$\geq 14 t_{CLCL}$	$> 4.0\mu s^1$
t_{RC}	SCL rise time	$\leq 1\mu s$	– ²
t_{FC}	SCL fall time	$\leq 0.3\mu s$	$< 0.3\mu s^3$
SDA TIMING CHARACTERISTICS			
$t_{SU; DAT1}$	Data set-up time	$\geq 250ns$	$> 20 t_{CLCL} - t_{RD}$
$t_{SU; DAT2}$	SDA set-up time (before rep. START cond.)	$\geq 250ns$	$> 1\mu s^1$
$t_{SU; DAT3}$	SDA set-up time (before STOP cond.)	$\geq 250ns$	$> 8 t_{CLCL}$
$t_{HD; DAT}$	Data hold time	$\geq 0ns$	$> 8 t_{CLCL} - t_{FC}$
$t_{SU; STA}$	Repeated START set-up time	$\geq 14 t_{CLCL}$	$> 4.7\mu s^1$
$t_{SU; STO}$	STOP condition set-up time	$\geq 14 t_{CLCL}$	$> 4.0\mu s^1$
t_{BUF}	Bus free time	$\geq 14 t_{CLCL}$	$> 4.7\mu s^1$
t_{RD}	SDA rise time	$\leq 1\mu s$	– ²
t_{FD}	SDA fall time	$\leq 0.3\mu s$	$< 0.3\mu s^3$

NOTES:

- At 100 kbit/s. At other bit rates this value is inversely proportional to the bit-rate of 100 kbit/s.
- Determined by the external bus-line capacitance and the external bus-line pull-resistor, this must be $< 1\mu s$.
- Spikes on the SDA and SCL lines with a duration of less than $3 t_{CLCL}$ will be filtered out. Maximum capacitance on bus-lines SDA and SCL = 400pF.
- $t_{CLCL} = 1/f_{osc}$ = one oscillator clock period at pin XTAL1. For $62ns (42ns) < t_{CLCL} < 285ns (16MHz (24MHz)) > f_{osc} > 3.5MHz$ the SIO1 interface meets the I²C-bus specification for bit-rates up to 100 kbit/s.

TIMING SIO1 (I²C) INTERFACE

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EXPLANATION OF THE AC SYMBOLS

Each timing symbol has five characters. The first character is always 't' (= time). The other characters, depending on their positions, indicate the name of a signal or the logical status of that signal. The designations are:

A – Address

C – Clock

D – Input data

H – Logic level high

I – Instruction (program memory contents)

L – Logic level low, or ALE

P – PSEN

Q – Output data

R – RD signal

t – Time

V – Valid

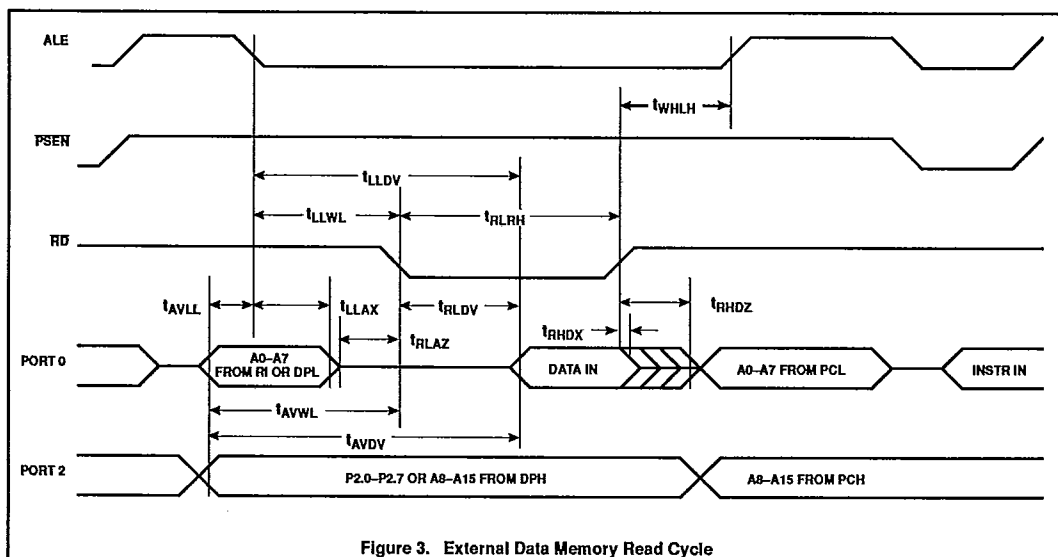
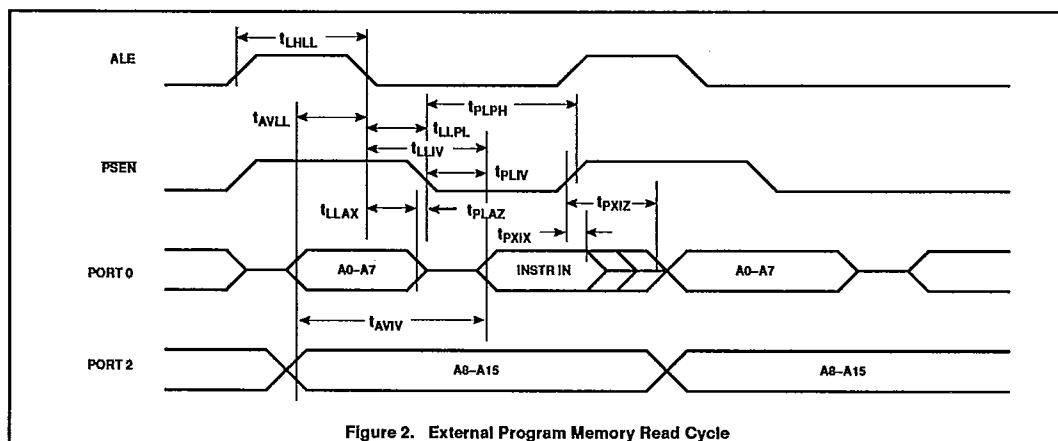
W – WR signal

X – No longer a valid logic level

Z – Float

Examples: t_{AVLL} = Time for address valid to ALE low.

t_{LLPL} = Time for ALE low to PSEN low.



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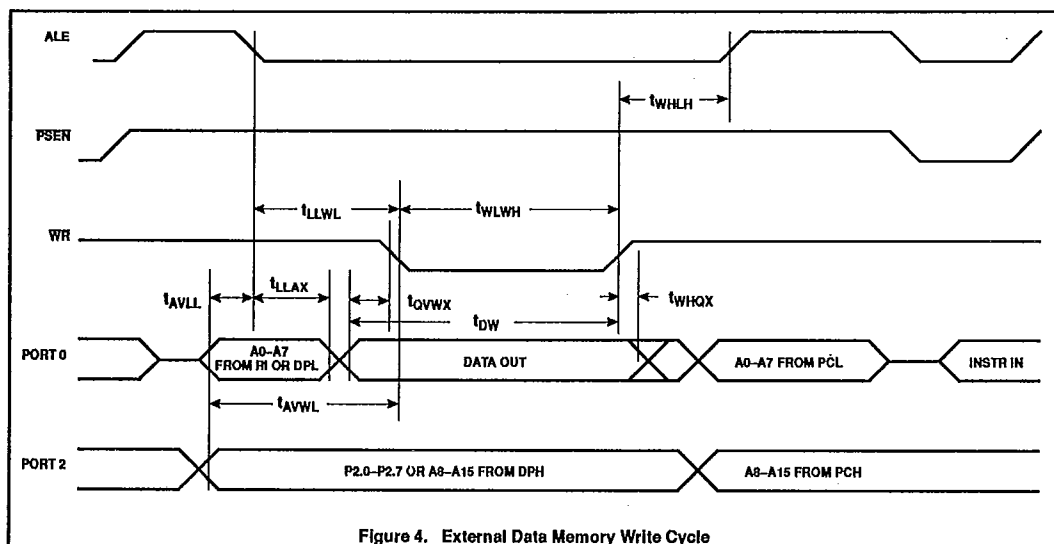


Figure 4. External Data Memory Write Cycle

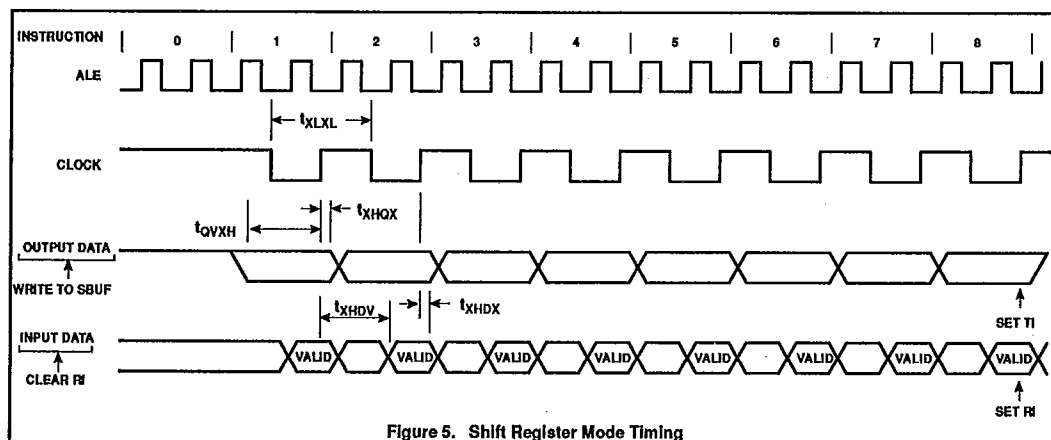
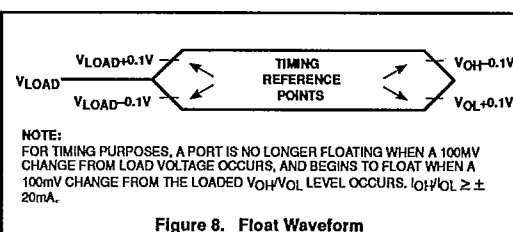
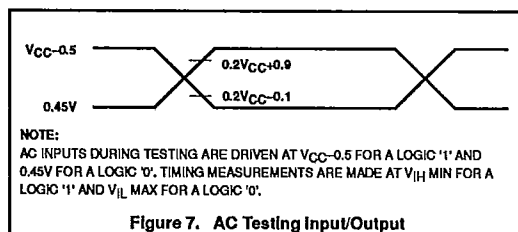
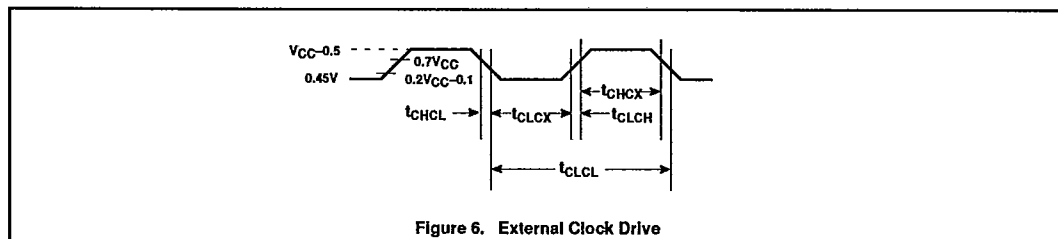


Figure 5. Shift Register Mode Timing

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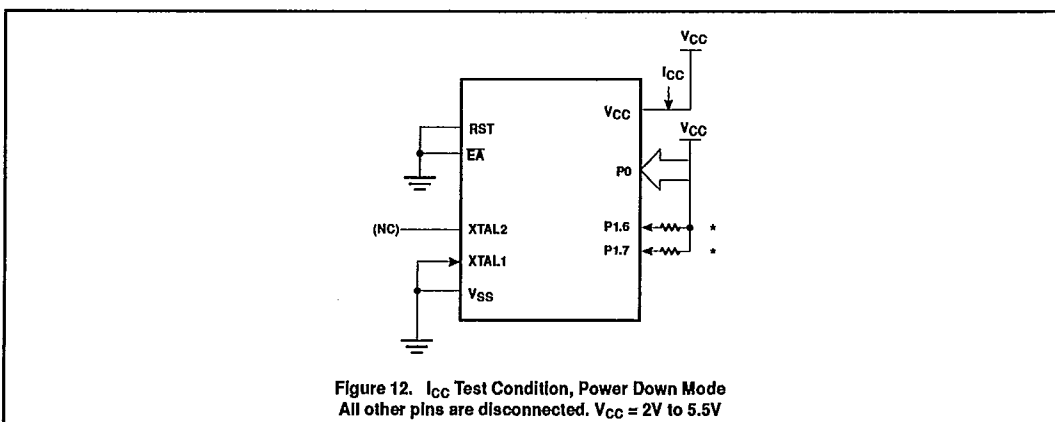
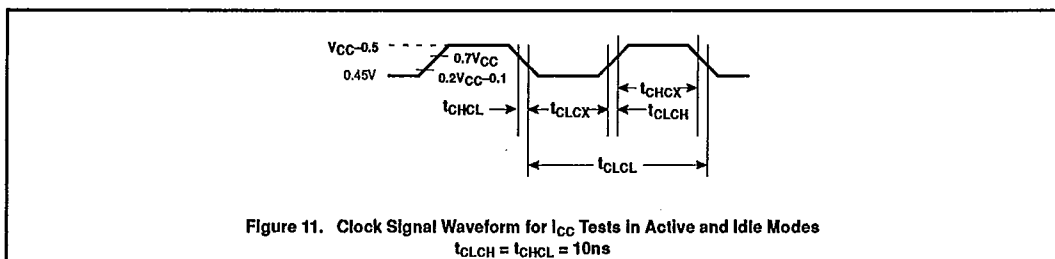
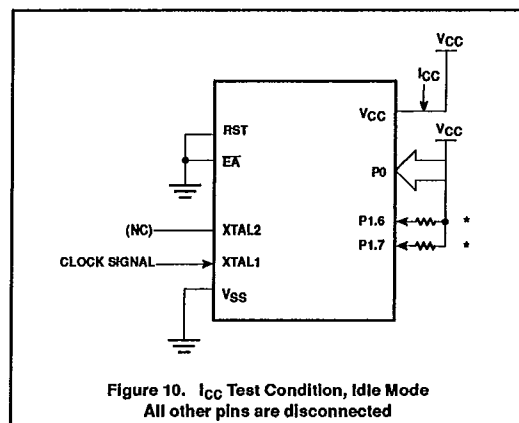
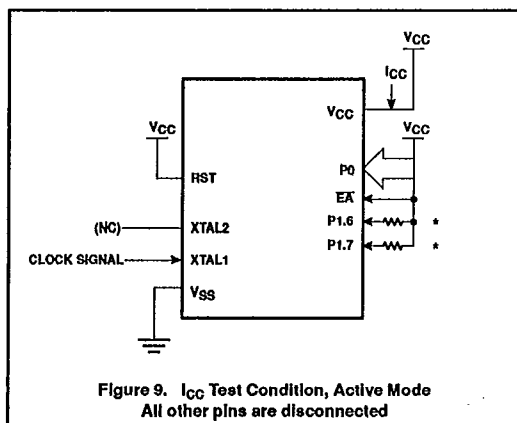
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NOTE:

- * Ports 1.6 and 1.7 should be connected to V_{CC} through resistors of sufficiently high value such that the sink current into these pins does not exceed the I_{OL1} specification.

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EPROM CHARACTERISTICS

The 87C654 is programmed by using a modified Quick-Pulse Programming™ algorithm. It differs from older methods in the value used for V_{PP} (programming supply voltage) and in the width and number of the ALE/PROG pulses.

The 87C654 contains two signature bytes that can be read and used by an EPROM programming system to identify the device. The signature bytes identify the device as an 87C654 manufactured by Philips Components.

Table 3 shows the logic levels for reading the signature byte, and for programming the program memory, the encryption table, and the lock bits. The circuit configuration and waveforms for quick-pulse programming are shown in Figures 13 and 14. Figure 15 shows the circuit configuration for normal program memory verification.

Quick-Pulse Programming

The setup for microcontroller quick-pulse programming is shown in Figure 13. Note that the 87C654 is running with a 4 to 6MHz oscillator. The reason the oscillator needs to be running is that the device is executing internal address and program data transfers.

The address of the EPROM location to be programmed is applied to ports 1 and 2, as shown in Figure 13. The code byte to be programmed into that location is applied to port 0. RST, PSEN and pins of ports 2 and 3 specified in Table 3 are held at the 'Program Code Data' levels indicated in Table 3. The ALE/PROG is pulsed low 25 times as shown in Figure 14.

To program the encryption table, repeat the 25 pulse programming sequence for addresses 0 through 1FH, using the 'Pgm Encryption Table' levels. Do not forget that after the encryption table is programmed, verification cycles will produce only encrypted data.

To program the lock bits, repeat the 25 pulse programming sequence using the 'Pgm Lock Bit' levels. After one lock bit is programmed, further programming of the code memory and encryption table is disabled. However, the other lock bit can still be programmed.

Note that the EA/ V_{PP} pin must not be allowed to go above the maximum specified V_{PP} level for any amount of time. Even a narrow glitch above that voltage can cause permanent damage to the device. The V_{PP} source should be well regulated and free of glitches and overshoot.

Program Verification

If lock bit 2 has not been programmed, the on-chip program memory can be read out for program verification. The address of the program memory locations to be read is applied to ports 1 and 2 as shown in Figure 15. The other pins are held at the 'Verify Code Data' levels indicated in Table 3. The contents of the address location will be emitted on port 0. External pull-ups are required on port 0 for this operation.

If the encryption table has been programmed, the data presented at port 0 will be the exclusive NOR of the program byte with one of the encryption bytes. The user will have to know the encryption table contents in order to correctly decode the verification data. The encryption table itself cannot be read out.

Reading the Signature Bytes

The signature bytes are read by the same procedure as a normal verification of locations 030H and 031H, except that P3.6 and P3.7 need to be pulled to a logic low. The values are:

(030H) = 15H indicates manufactured by Philips

(031H) = 99H indicates 87C654

Program/Verify Algorithms

Any algorithm in agreement with the conditions listed in Table 3, and which satisfies the timing specifications, is suitable.

Erasure Characteristics

Erasure of the EPROM begins to occur when the chip is exposed to light with wavelengths shorter than approximately 4,000 angstroms. Since sunlight and fluorescent lighting have wavelengths in this range, exposure to these light sources over an extended time (about 1 week in sunlight, or 3 years in room level fluorescent lighting) could cause inadvertent erasure. **For this and secondary effects, it is recommended that an opaque label be placed over the window.** For elevated temperature or environments where solvents are being used, apply Kapton tape Fluorglas part number 2345-5, or equivalent.

The recommended erasure procedure is exposure to ultraviolet light (at 2537 angstroms) to an integrated dose of at least 15W-sec/cm². Exposing the EPROM to an ultraviolet lamp of 12,000uW/cm² rating for 20 to 39 minutes, at a distance of about 1 inch, should be sufficient. Erasure leaves the array in an all 1s state.

Table 3. EPROM Programming Modes

MODE	RST	PSEN	ALE/PROG	EA/ V_{PP}	P2.7	P2.6	P3.7	P3.6
Read signature	1	0	1	1	0	0	0	0
Program code data	1	0	0*	V_{PP}	1	0	1	1
Verify code data	1	0	1	1	0	0	1	1
Pgm encryption table	1	0	0*	V_{PP}	1	0	1	0
Pgm lock bit 1	1	0	0*	V_{PP}	1	1	1	1
Pgm lock bit 2	1	0	0*	V_{PP}	1	1	0	0

NOTES:

1. '0' = Valid low for that pin, '1' = valid high for that pin.

2. V_{PP} = 12.75V \pm 0.25V.

3. V_{CC} = 5V \pm 10% during programming and verification.

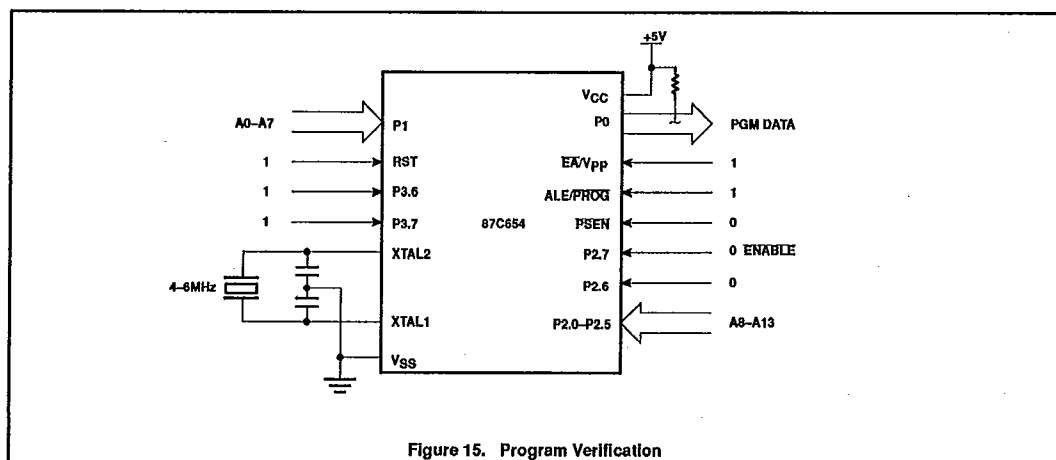
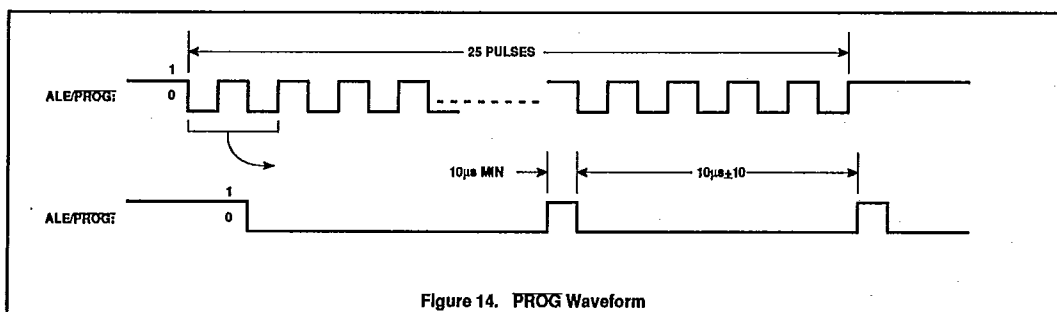
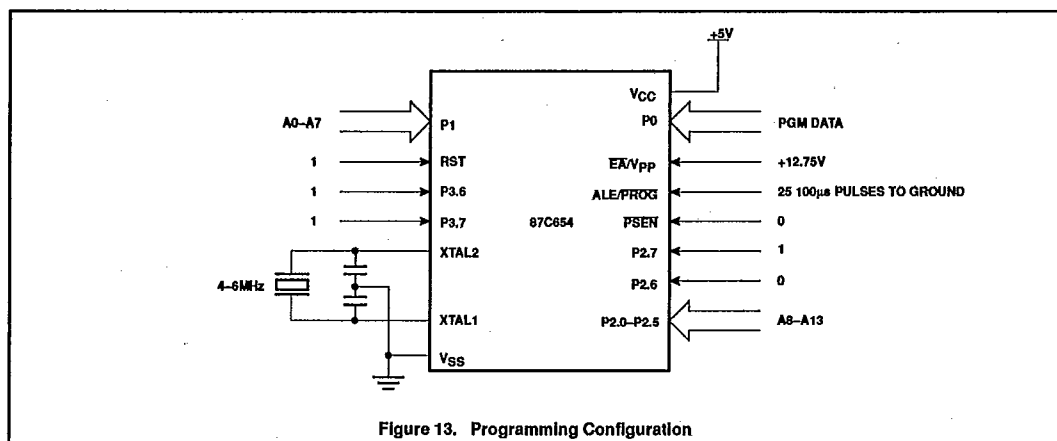
* ALE/PROG receives 25 programming pulses while V_{PP} is held at 12.75V. Each programming pulse is low for 100 μ s (\pm 10 μ s) and high for a minimum of 10 μ s.

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EPROM PROGRAMMING AND VERIFICATION CHARACTERISTICS

 $T_{amb} = 21^{\circ}\text{C}$ to $+27^{\circ}\text{C}$, $V_{CC} = 5\text{V} \pm 10\%$, $V_{SS} = 0\text{V}$ (See Figure 16)

SYMBOL	PARAMETER	MIN	MAX	UNIT
V_{PP}	Programming supply voltage	12.5	13.0	V
I_{PP}	Programming supply current		50	mA
$1/t_{CLCL}$	Oscillator frequency	4	6	MHz
t_{AVGL}	Address setup to PROG low	$48t_{CLCL}$		
t_{GHAX}	Address hold after PROG	$48t_{CLCL}$		
t_{DVGL}	Data setup to PROG low	$48t_{CLCL}$		
t_{GHDX}	Data hold after PROG	$48t_{CLCL}$		
t_{EHS}	P2.7 (ENABLE) high to V_{PP}	$48t_{CLCL}$		
t_{SHGL}	V_{PP} setup to PROG low	10		μs
t_{GHS}	V_{PP} hold after PROG	10		μs
t_{GLGH}	PROG width	90	110	μs
t_{AVQV}	Address to data valid		$48t_{CLCL}$	
t_{ELOZ}	ENABLE low to data valid		$48t_{CLCL}$	
t_{EHOZ}	Data float after ENABLE	0	$48t_{CLCL}$	
t_{GHGL}	PROG high to PROG low	10		μs

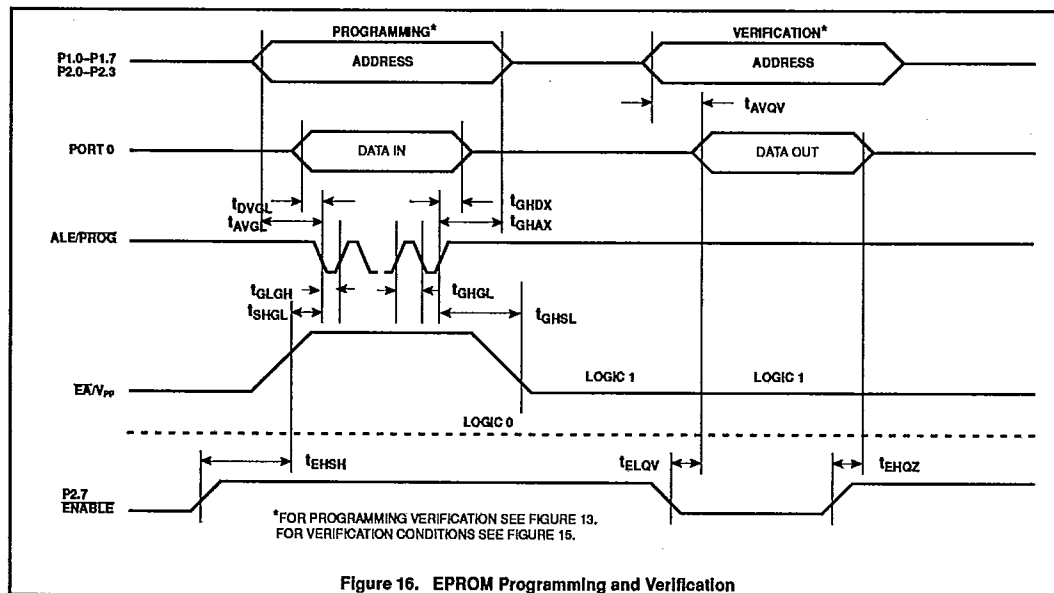


Figure 16. EPROM Programming and Verification



Purchase of Philips' I²C components conveys a license under the Philips' I²C patent to use the components in the I²C-system provided the system conforms to the I²C specifications defined by Philips.